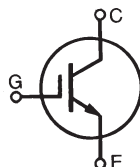


### High Voltage IGBTs

### IXGK75N250

### IXGX75N250

### For Capacitor Discharge Applications



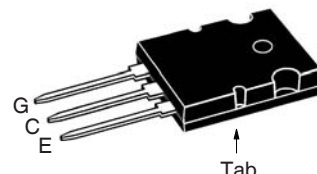
$$V_{CES} = 2500V$$

$$I_{C110} = 75A$$

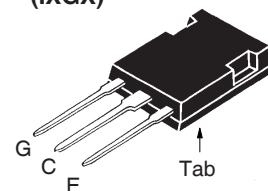
$$V_{CE(sat)} \leq 2.7V$$

| Symbol                        | Test Conditions                                                                      | Maximum Ratings                         |             |
|-------------------------------|--------------------------------------------------------------------------------------|-----------------------------------------|-------------|
| $V_{CES}$                     | $T_J = 25^{\circ}C$ to $150^{\circ}C$                                                | 2500                                    | V           |
| $V_{CGR}$                     | $T_J = 25^{\circ}C$ to $150^{\circ}C$ , $R_{GE} = 1M\Omega$                          | 2500                                    | V           |
| $V_{GES}$                     | Continuous                                                                           | $\pm 20$                                | V           |
| $V_{GEM}$                     | Transient                                                                            | $\pm 30$                                | V           |
| $I_{C25}$                     | $T_C = 25^{\circ}C$ ( Chip Capability )                                              | 170                                     | A           |
| $I_{C110}$                    | $T_C = 110^{\circ}C$                                                                 | 75                                      | A           |
| $I_{LRMS}$                    | $T_C = 25^{\circ}C$ (Lead RMS Limit)                                                 | 160                                     | A           |
| $I_{CM}$                      | $T_C = 25^{\circ}C$ , $V_{GE} = 20V$ , 1ms                                           | 530                                     | A           |
| <b>SSOA</b><br><b>(RBSOA)</b> | $V_{GE} = 15V$ , $T_{VJ} = 125^{\circ}C$ , $R_G = 1\Omega$<br>Clamped Inductive Load | $I_{CM} = 200$<br>@ $0.8 \cdot V_{CES}$ | A           |
| $P_C$                         | $T_C = 25^{\circ}C$                                                                  | 780                                     | W           |
| $T_J$                         |                                                                                      | -55 ... +150                            | $^{\circ}C$ |
| $T_{JM}$                      |                                                                                      | 150                                     | $^{\circ}C$ |
| $T_{stg}$                     |                                                                                      | -55 ... +150                            | $^{\circ}C$ |
| $T_L$                         | Maximum Lead Temperature for Soldering                                               | 300                                     | $^{\circ}C$ |
| $T_{SOLD}$                    | 1.6 mm (0.062 in.) from Case for 10                                                  | 260                                     | $^{\circ}C$ |
| $M_d$                         | Mounting Torque ( IXGK )                                                             | 1.13/10                                 | Nm/lb.in.   |
| $F_C$                         | Mounting Force ( IXGX )                                                              | 20..120/4.5..27                         | N/lb.       |
| <b>Weight</b>                 | TO-264                                                                               | 10                                      | g           |
|                               | PLUS247                                                                              | 6                                       | g           |

TO-264 (IXGK)



PLUS247™ (IXGX)



G = Gate                      E = Emitter  
C = Collector                Tab = Collector

### Features

- Very High Peak Current Capability
- Low Saturation Voltage
- MOS Gate Turn-On
- Rugged NPT Structure
- Molding Epoxies meet UL 94V-0 Flammability Classification

### Advantages

- Easy to Mount
- Space Savings
- High Power Density

### Applications

- Capacitor Discharge
- Pulser Circuits

| Symbol        | Test Conditions<br>( $T_J = 25^{\circ}C$ , Unless Otherwise Specified) | Characteristic Values |      |                    |
|---------------|------------------------------------------------------------------------|-----------------------|------|--------------------|
|               |                                                                        | Min.                  | Typ. | Max.               |
| $BV_{CES}$    | $I_C = 1mA$ , $V_{CE} = 0V$                                            | 2500                  |      | V                  |
| $V_{GE(th)}$  | $I_C = 4mA$ , $V_{CE} = V_{GE}$                                        | 3.0                   |      | 5.0 V              |
| $I_{CES}$     | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 125^{\circ}C$             |                       |      | 50 $\mu A$<br>5 mA |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                     |                       |      | $\pm 200$ nA       |
| $V_{CE(sat)}$ | $I_C = 75A$ , $V_{GE} = 15V$ , Note 1                                  |                       |      | 2.7 V              |
|               | $I_C = 150A$                                                           |                       |      | 3.6 V              |

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)                                                  | Characteristic Values |      |                        |
|--------------|------------------------------------------------------------------------------------------------------------------------------|-----------------------|------|------------------------|
|              |                                                                                                                              | Min.                  | Typ. | Max.                   |
| $g_{fs}$     | $I_C = 60\text{A}$ , $V_{CE} = 10\text{V}$ , Note 1                                                                          | 35                    | 58   | S                      |
| $C_{ies}$    | $V_{CE} = 25\text{V}$ , $V_{GE} = 0\text{V}$ , $f = 1\text{MHz}$                                                             |                       | 9000 | pF                     |
| $C_{oes}$    |                                                                                                                              |                       | 345  | pF                     |
| $C_{res}$    |                                                                                                                              |                       | 110  | pF                     |
| $Q_g$        | $I_C = 75\text{A}$ , $V_{GE} = 15\text{V}$ , $V_{CE} = 0.5 \cdot V_{CES}$                                                    |                       | 410  | nC                     |
| $Q_{ge}$     |                                                                                                                              |                       | 63   | nC                     |
| $Q_{gc}$     |                                                                                                                              |                       | 175  | nC                     |
| $t_{d(on)}$  | <b>Resistive Switching Times</b><br>$I_C = 150\text{A}$ , $V_{GE} = 15\text{V}$<br>$V_{CE} = 1250\text{V}$ , $R_G = 1\Omega$ |                       | 55   | ns                     |
| $t_r$        |                                                                                                                              |                       | 225  | ns                     |
| $t_{d(off)}$ |                                                                                                                              |                       | 270  | ns                     |
| $t_f$        |                                                                                                                              |                       | 455  | ns                     |
| $R_{thJC}$   |                                                                                                                              |                       |      | $0.16^\circ\text{C/W}$ |
| $R_{thCK}$   |                                                                                                                              |                       | 0.15 | $^\circ\text{C/W}$     |

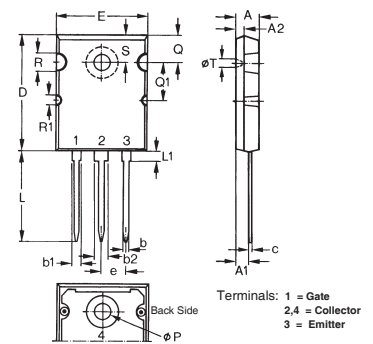
Note 1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .

\*Additional provision for lead-to-lead voltage isolation are required at  $V_{CE} > 1200\text{V}$ .

### PRELIMINARY TECHNICAL INFORMATION

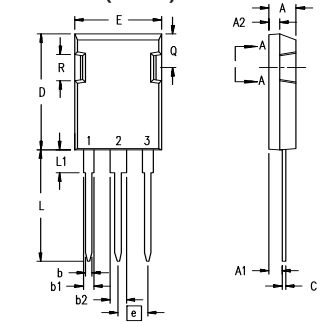
The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

### TO-264 AA (IXGK) Outline



| Dim. | Millimeter<br>Min. | Max.  | Inches<br>Min. | Max.  |
|------|--------------------|-------|----------------|-------|
| A    | 4.82               | 5.13  | .190           | .202  |
| A1   | 2.54               | 2.89  | .100           | .114  |
| A2   | 2.00               | 2.10  | .079           | .083  |
| b    | 1.12               | 1.42  | .044           | .056  |
| b1   | 2.39               | 2.69  | .094           | .106  |
| b2   | 2.90               | 3.09  | .114           | .122  |
| c    | 0.53               | 0.83  | .021           | .033  |
| D    | 25.91              | 26.16 | 1.020          | 1.030 |
| E    | 19.81              | 19.96 | .780           | .786  |
| e    | 5.46               | BSC   | .215           | BSC   |
| J    | 0.00               | 0.25  | .000           | .010  |
| K    | 0.00               | 0.25  | .000           | .010  |
| L    | 20.32              | 20.83 | .800           | .820  |
| L1   | 2.29               | 2.59  | .090           | .102  |
| P    | 3.17               | 3.66  | .125           | .144  |
| Q    | 6.07               | 6.27  | .239           | .247  |
| Q1   | 8.38               | 8.69  | .330           | .342  |
| R    | 3.81               | 4.32  | .150           | .170  |
| R1   | 1.78               | 2.29  | .070           | .090  |
| S    | 6.04               | 6.30  | .238           | .248  |
| T    | 1.57               | 1.83  | .062           | .072  |

### PLUS247™ (IXGX) Outline



Terminals: 1 - Gate  
2 - Collector  
3 - Emitter

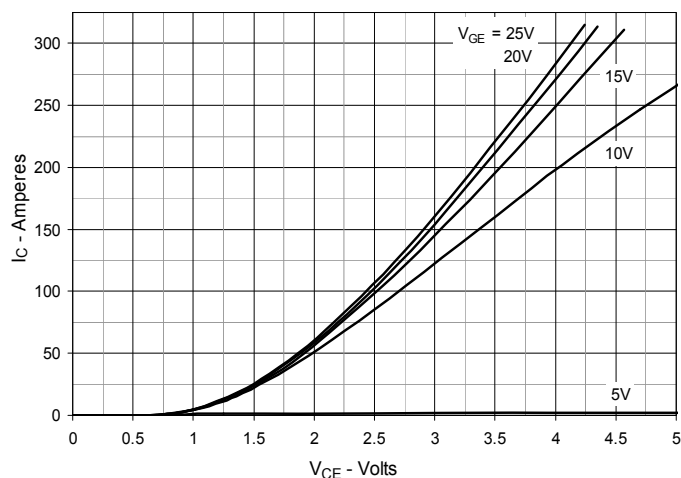
| Dim. | Millimeter<br>Min. | Max.  | Inches<br>Min. | Max.  |
|------|--------------------|-------|----------------|-------|
| A    | 4.83               | 5.21  | .190           | .205  |
| A1   | 2.29               | 2.54  | .090           | .100  |
| A2   | 1.91               | 2.16  | .075           | .085  |
| b    | 1.14               | 1.40  | .045           | .055  |
| b1   | 1.91               | 2.13  | .075           | .084  |
| b2   | 2.92               | 3.12  | .115           | .123  |
| C    | 0.61               | 0.80  | .024           | .031  |
| D    | 20.80              | 21.34 | .819           | .840  |
| E    | 15.75              | 16.13 | .620           | .635  |
| e    | 5.45               | BSC   | .215           | BSC   |
| L    | 19.81              | 20.32 | .780           | .800  |
| L1   | 3.81               | 4.32  | .150           | .170  |
| Q    | 5.59               | 6.20  | .220           | 0.244 |
| R    | 4.32               | 4.83  | .170           | .190  |

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

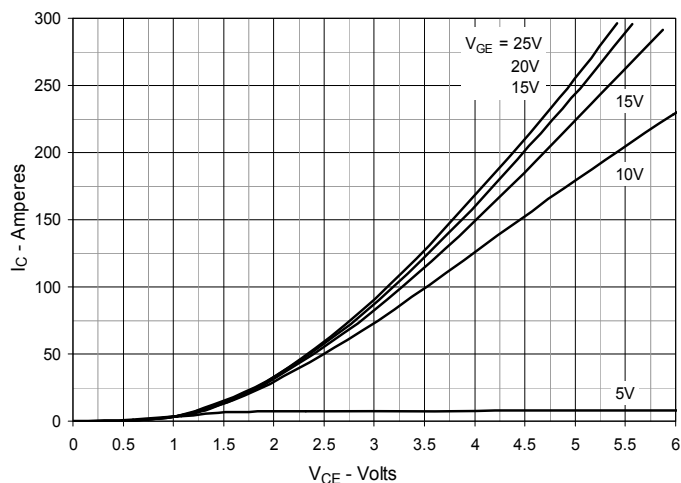
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

|           |           |           |           |              |              |              |              |              |             |
|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338B2 |
| 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |             |
| 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |             |

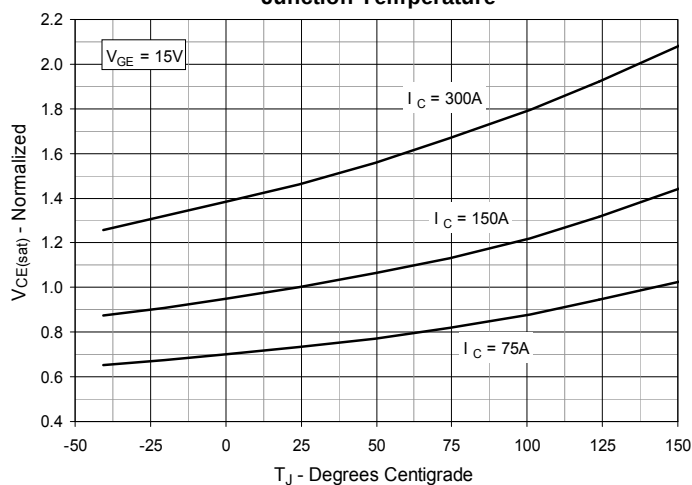
**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$**



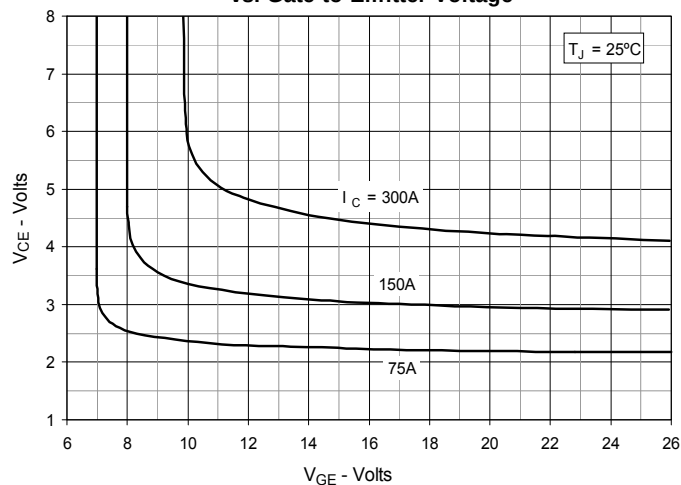
**Fig. 2. Output Characteristics @  $T_J = 125^\circ\text{C}$**



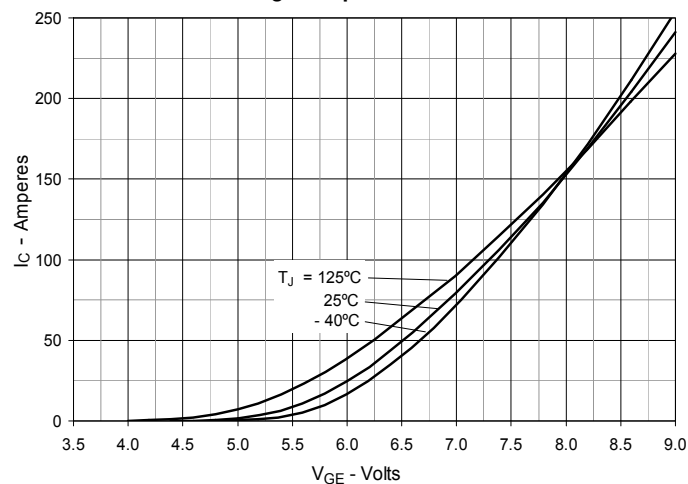
**Fig. 3. Dependence of  $V_{CE(sat)}$  on Junction Temperature**



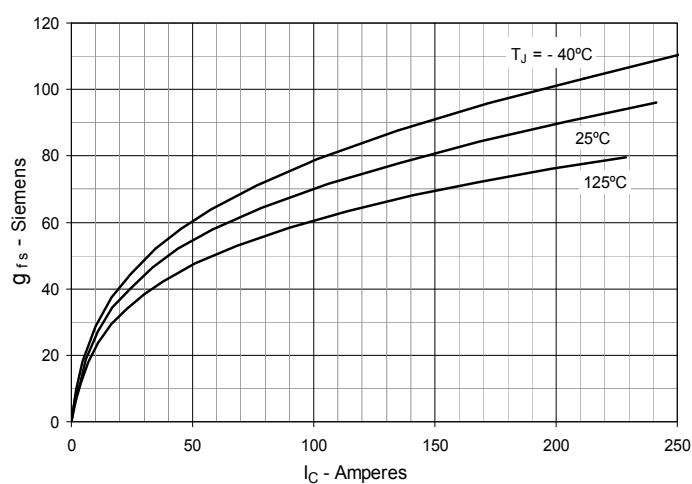
**Fig. 4. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**



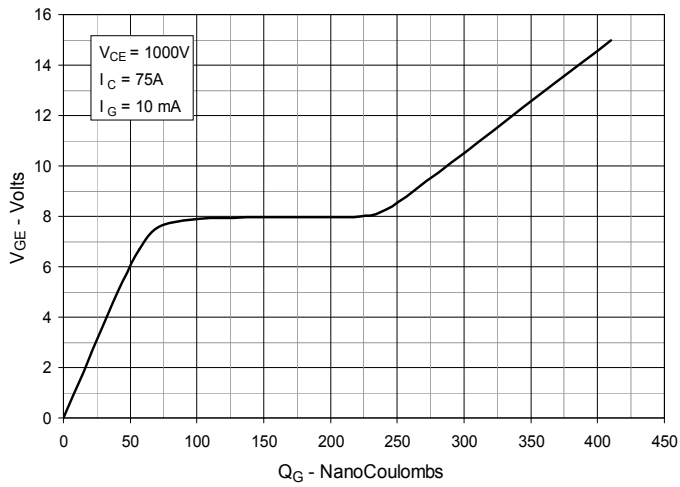
**Fig. 5. Input Admittance**



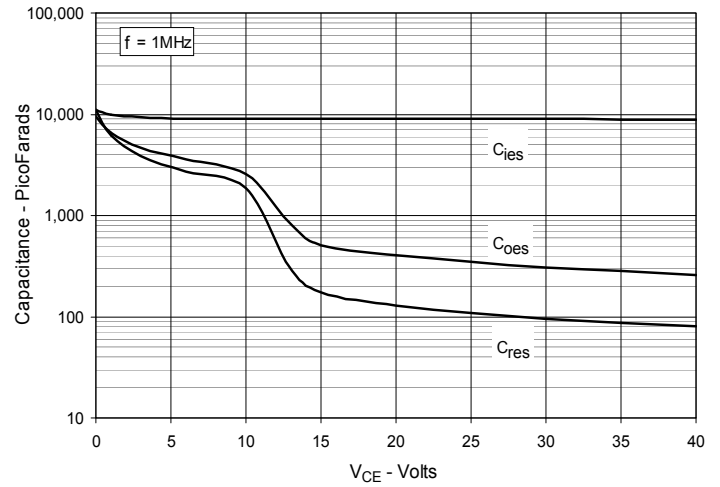
**Fig. 6. Transconductance**



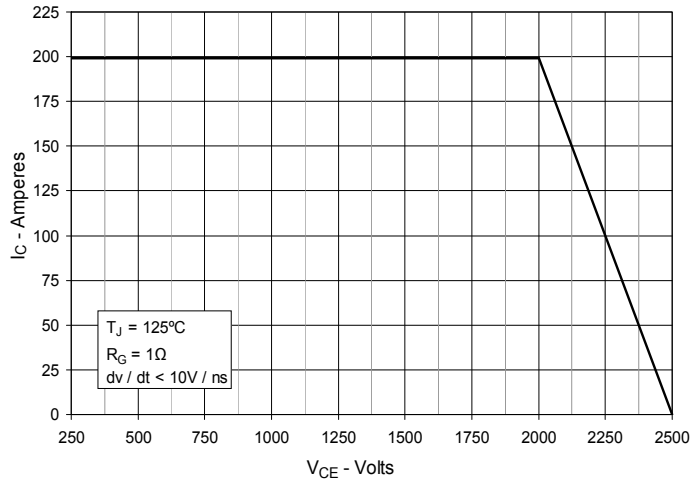
**Fig. 7. Gate Charge**



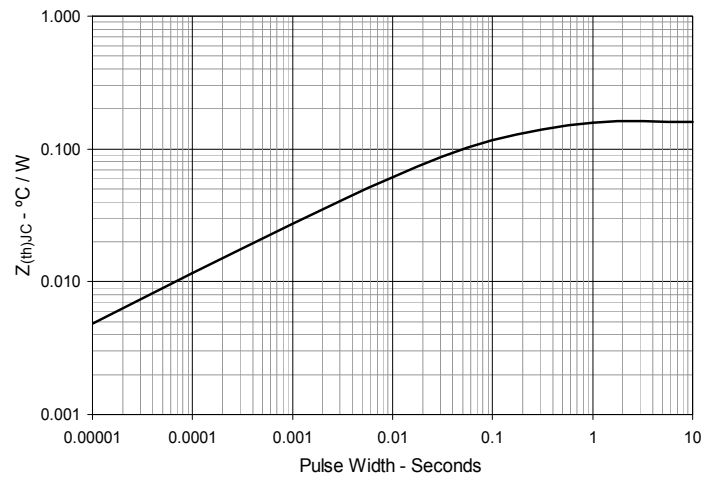
**Fig. 8. Capacitance**

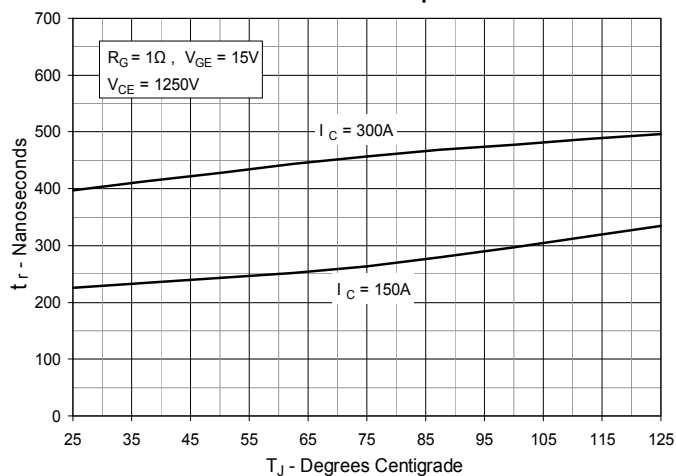
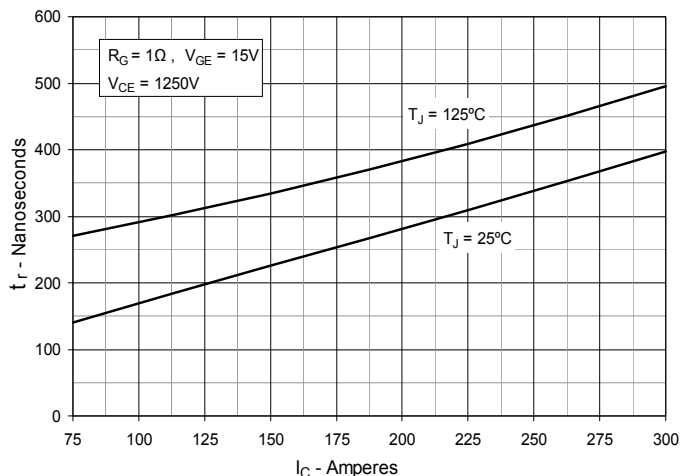
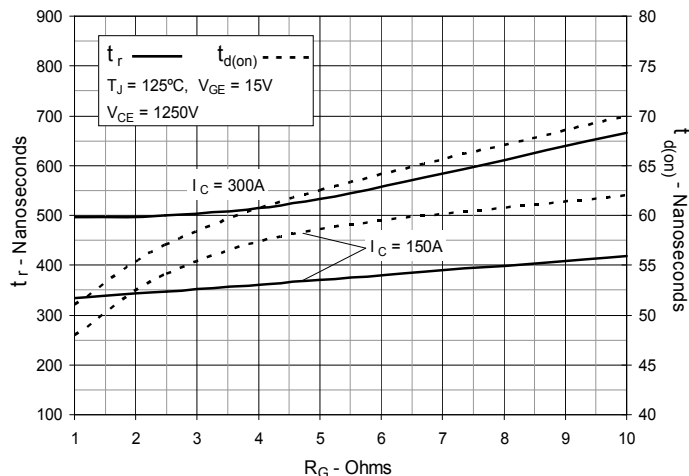
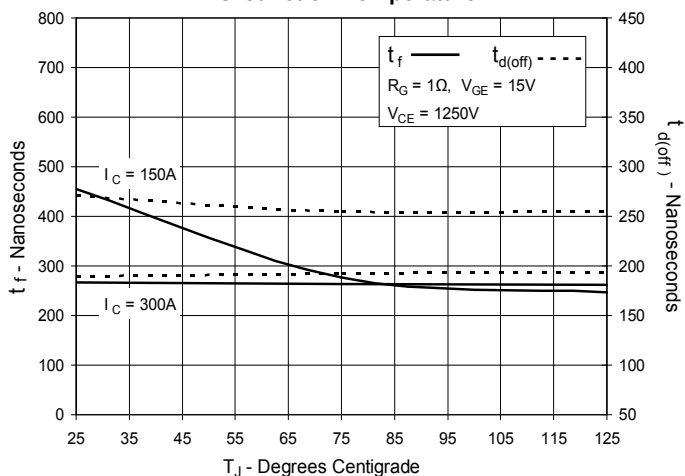
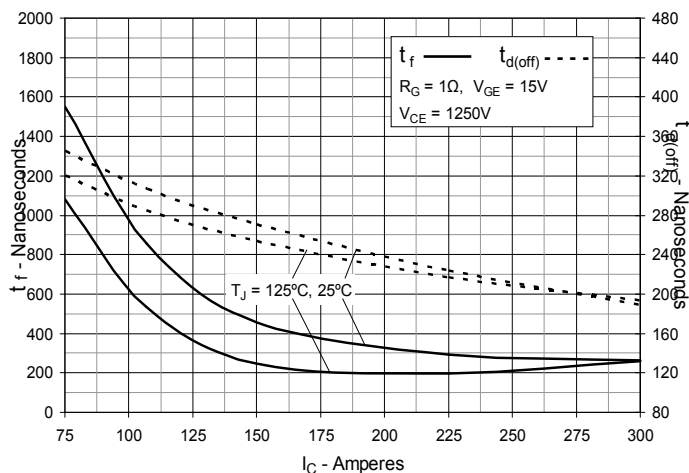
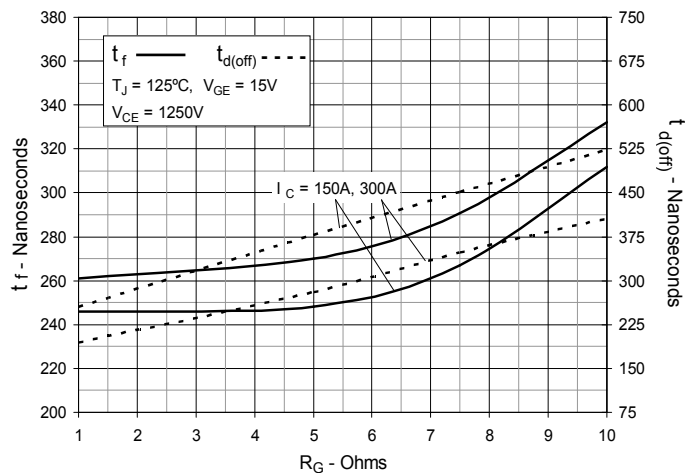


**Fig. 9. Reverse-Bias Safe Operating Area**



**Fig. 10. Maximum Transient Thermal Impedance**



**Fig. 11. Resistive Turn-on Rise Time vs. Junction Temperature**

**Fig. 12. Resistive Turn-on Rise Time vs. Collector Current**

**Fig. 13. Resistive Turn-on Switching Times vs. Gate Resistance**

**Fig. 14. Resistive Turn-off Switching Times vs. Junction Temperature**

**Fig. 15. Resistive Turn-off Switching Times vs. Collector Current**

**Fig. 16. Resistive Turn-off Switching Times vs. Gate Resistance**




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